

DESCRIPTION

This series of surface mount diodes are specifically design for high volume surface mount applications. The GigaMite design is optimized for improved electrical and thermal performance over standard plastic package technology. Our patented dual orthogonal lead frame provides both exceptionally low thermal impedance and series inductance. Microsemi utilizes only the highest quality dielectric materials resulting in low loss tangent and physical stability even in harsh environments. The result is higher frequency coverage and greater stability than comparable plastic packages.

This series of devices meets RoHS requirements per EU Directive 2002/95/EC.

KEY FEATURES

- Low Parasitics
 $L_P = 0.5 \text{ nH Typical}$
 $C_P = 0.07 \text{ pF Typical}$
- Surface Mount design
- Broadband Performance Through 5 GHz
- Available on Tape & Reel for Automated Pick & Place Assembly
- Small, SOD 323 Size Footprint
- RoHS Compliant ¹

APPLICATIONS

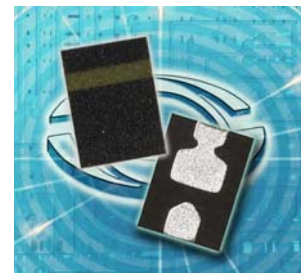
Microsemi Lowell offers a variety of Varactor diodes in the GigaMite package style. Their low internal series inductance makes these products well suited for VCOs and VVFs through 5 GHz. Choose GMV1981 for low voltage battery applications. GMV15007 offers state of the art frequency linearity. GMV2114, GMV2134, and GMV2154 offer smooth wide ratio 20V tuning. GMV1542 offers high Q performance for lowest phase noise and loss.

APPLICATIONS/BENEFITS

- Frequency Linear VCO's
- Low Phase Noise VCO's
- Wide Bandwidth VCO's
- Voltage variable Filters
- Analog Phase Shifters
- VCXO's
- Performance through 5 GHz

ABSOLUTE MAXIMUM RATINGS AT 25° C (UNLESS OTHERWISE SPECIFIED)

Rating	Symbol	Value	Unit
Maximum Leakage Current @80% of Rated V_B	I_R	100	nA
Storage Temperature	T_{STG}	-55 to +125	°C
Operating Temperature	T_{OP}	-55 to +125	°C



IMPORTANT: Specifications are subject to change.

For the most current data visit: www.MICROSEMI.com



These devices are ESD sensitive and must be handled using ESD precautions

¹ These devices are supplied with a matte tin finish suitable for RoHS compliant assembly.



Microsemi[®]

GMV1000 / GMV2100 / GMV5000

GigaMite™
Surface Mount Varactor Diodes
RoHS Compliant


Low Voltage / High Sensitivity Varactors

ELECTRICAL PARAMETERS @ 25°C (unless otherwise specified)						
Model Number	V _b (V) I _r =10μA (Min)	C _T (pF) ¹ @ V _r =1V (Min)	C _T (pF) ¹ @ V _r =2.5V (Min – Max)	C _T (pF) ¹ @ V _r =4V (Max)	C _T (pF) ¹ @ V _r =8V (Typ)	Q ² (Min)
GMV1981-GM1	12	1.2	0.7 – 1.1	0.5	0.25	1200

22V FLTVAR GigaMite

ELECTRICAL PARAMETERS @ 25°C (unless otherwise specified)						
Model Number	V _b (V) I _r =10μA (Min)	C _T (pF) ¹ @ V _r =0V (Min)	C _T (pF) ¹ @ V _r =4V (Min – Max)	C _T (pF) ¹ @ V _r =20V (Max)	Ratio C _{T0} /C _{T20} (Typ)	Q ² (Min)
GMV15007-GM1	22	2.5	0.9 – 1.3	0.5	8:1	1000

22V HyperAbrupt GigaMite

ELECTRICAL PARAMETERS @ 25°C (unless otherwise specified)						
Model Number	V _b (V) I _r =10μA (Min)	C _T (pF) ¹ @ V _r =0V (Min)	C _T (pF) ¹ @ V _r =4V (Min-Max)	C _T (pF) ¹ @ V _r =20V (Max)	Ratio C _{T4} /C _{T20} (Typ)	Q ² (Min)
GMV2114-GM1	22	2.1	0.8 – 1.1	0.5	3.0	900
GMV2134-GM1	22	4.9	1.7 – 2.2	0.7	3.7	750
GMV2154-GM1	22	14	4.4 – 5.5	1.3	4.1	600

30V Abrupt Junction GigaMite

ELECTRICAL PARAMETERS @ 25°C (unless otherwise specified)						
Model Number	V _b (V) I _r =10μA (Min)	C _T (pF) ¹ @ V _r =0V (Min)	C _T (pF) ¹ @ V _r =4V (Min-Max)	C _T (pF) ¹ @ V _r =30V (Max)	Ratio C _{T0} /C _{T30} (Typ)	Q ² (Min)
GMV1542-GM1	30	2.4	1.0 – 1.3	0.75	3.4	3800

1. $f = 1\text{ MHz}$.
2. $V = 4\text{ V}$, $f = 50\text{ MHz}$



Microsemi[®]

GMV1000 / GMV2100 / GMV5000

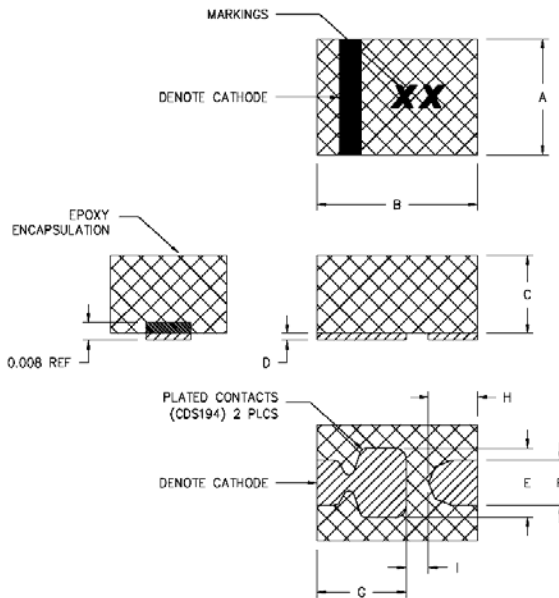
GigaMite[™]

Surface Mount Varactor Diodes

RoHS Compliant

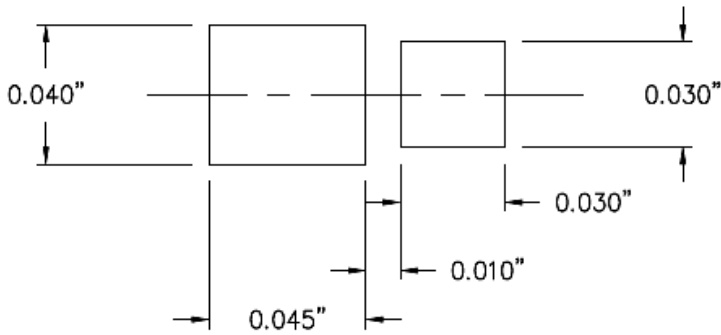


PACKAGE STYLE GM1

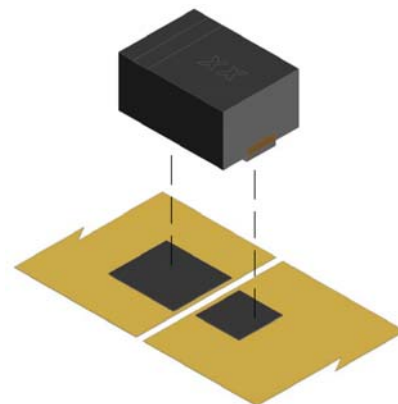


DIM	INCHES			MM		
	MIN	TYP	MAX	MIN	TYP	MAX
A	0.047	0.052	0.057	1.194	1.321	1.448
B	0.067	0.072	0.077	1.702	1.829	1.956
C	0.030	0.035	0.040	0.762	0.889	1.016
D	—	—	0.003	—	—	0.076
E	0.028	0.031	0.034	0.711	0.787	0.864
F	0.017	0.020	0.023	0.432	0.508	0.584
G	0.035	0.040	0.045	0.889	1.016	1.143
H	0.017	0.022	0.027	0.432	0.559	0.686
I	—	0.010	—	—	0.254	—

SUGGESTED SOLDER PAD LAYOUT



SUGGESTED SOLDER
PAD LAYOUT



www.MICROSEMI.com

PACKAGE STYLE